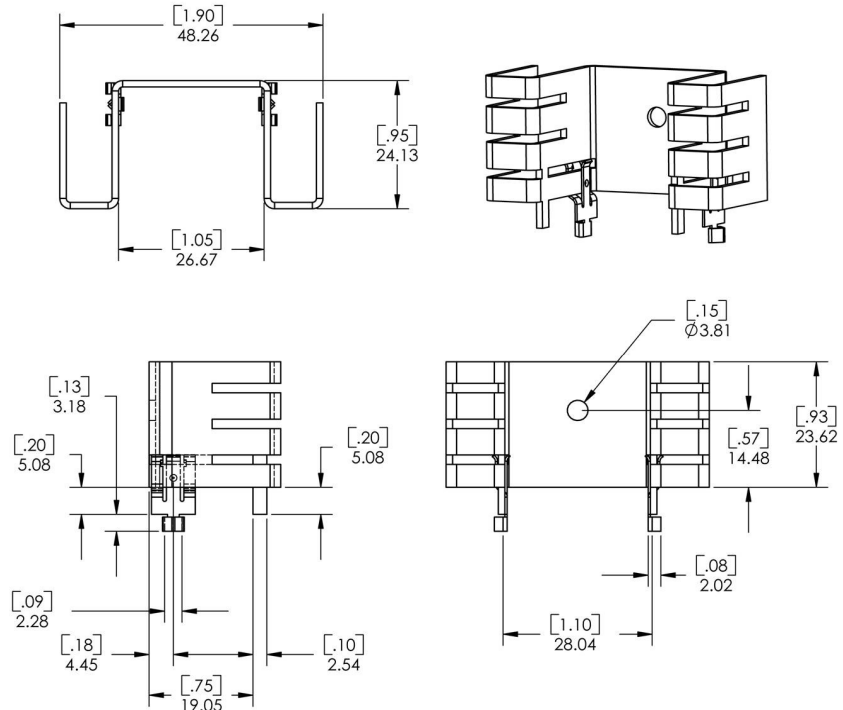
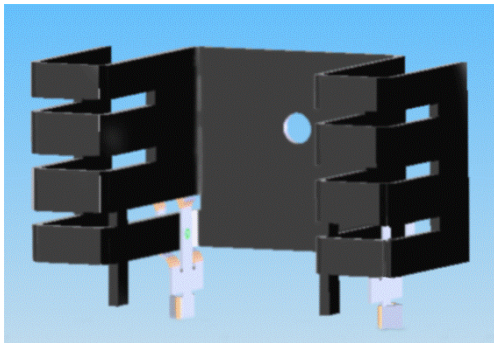


Board Level Heat Sinks



ThermaFlo

P/N: 825902B05300



PRODUCT SPECIFICATIONS

- Devices: TO-220
- Size: 24.1 x 48.3 x 23.6 mm
- Material: Aluminum, 1.2 mm thick
- Type: Stamped
- Finish: Black Anodized
- PCB Mounting: Solderable Tabs
- Package: Bulk
- Accessories: Hardware & Thermal Interface Material

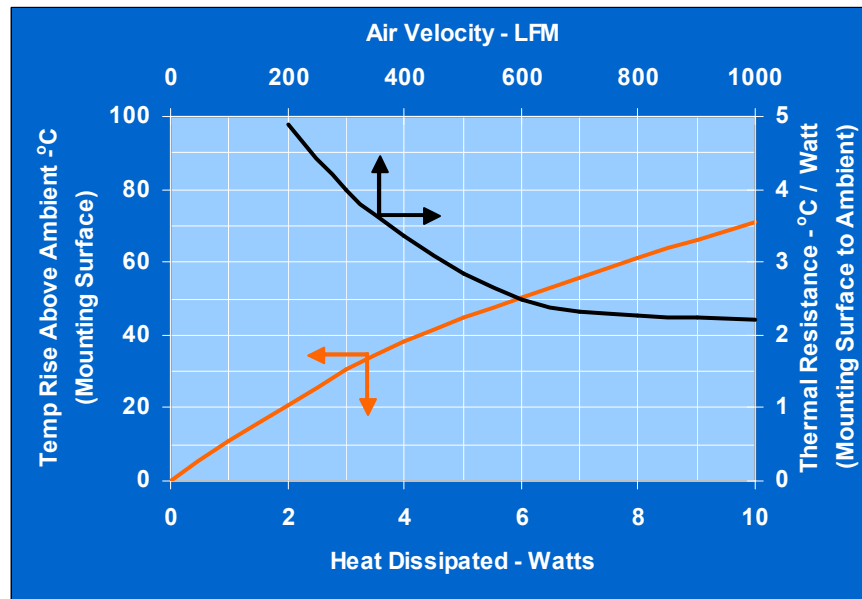
FEATURES & BENEFITS

- Hole for Device Attachment
- Vertical Mounting via Solderable Tabs
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Tabs, Plating
- Specialized Body Configurations
- Contact Applications Engineering



TO-220

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